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| Form PTO-1449 | U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE | ATTY. DKT. NO. 501.39082X00 | SERIAL NO. 09/646,671 |
| INFORMATION DISCLOSURE STATEMENT BY APPLICANT (Use several sheets if necessary) | | APPLICANT UNO, et al. | |
| | | FILING DATE September 20, 2000 | GROUP IB |

2812

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